

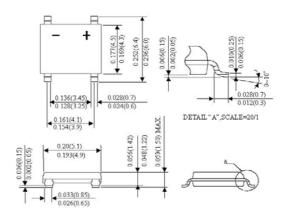
# ABS2 THRU ABS10

Voltage Range 200 to 1000 Volts Current 1.0 Ampere

### **Features**

- ♦ Glass passivated junction
- ♦ Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- → High temperature soldering guaranteed: 260°C / 10 seconds / 0.375" ( 9.5mm ) lead length at 5 lbs., ( 2.3 kg ) tension
- High surge current capability

#### MINI-SOP



Dimensions in inches and (millimeters)

## **Maximum Ratings and Electrical Characteristics**

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

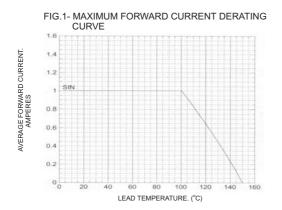
Type Number	Symbol	ABS2	ABS4	ABS6	ABS8	ABS10	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	200	400	600	800	1000	V
Maximum Average Forward Rectified Current On glass-epoxy P.C.B. On aluminum substrate	I <sub>(AV)</sub>	0.8 1.0					Α
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	30					Α
Maximum Instantaneous Forward Voltage @ 0.4A	$V_{F}$	095					V
Maximum DC Reverse Current @ T <sub>A</sub> =25℃ at Rated DC Blocking Voltage	I <sub>R</sub>	10					uA uA
Typical Thermal resistance Junction to Lead On aluminum substrate On Glass-Epoxy substrate	Rθ <sub>JL</sub> Rθ <sub>JA</sub>	25 62.5 80					<b>.c∖M</b>
Operating Temperature Range	$T_J$	-55 to +150					$^{\circ}$
Storage Temperature Range	$T_{STG}$	-55 to +150					$^{\circ}$

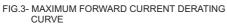


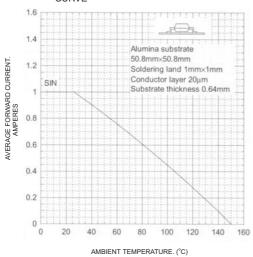
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### RATINGS AND CHARACTERISTIC CURVES (ABS2 THRU ABS10)







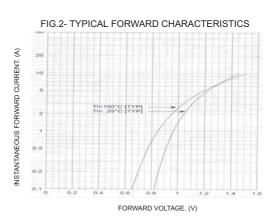


FIG.4- FORWARD POWER DISSIPATION

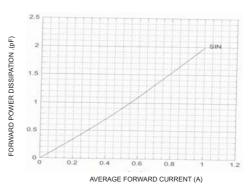
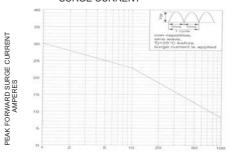


FIG.5- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



NUMBER OF CYCLES (CYCLE)